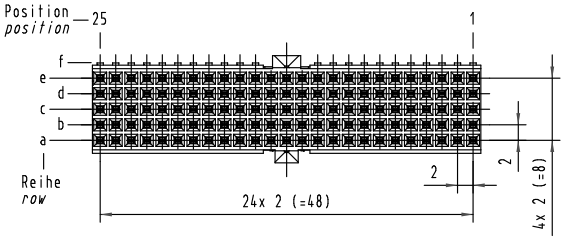
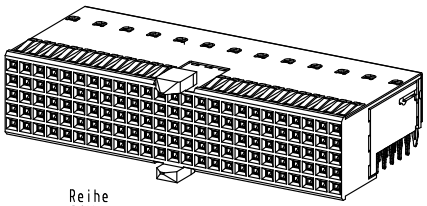
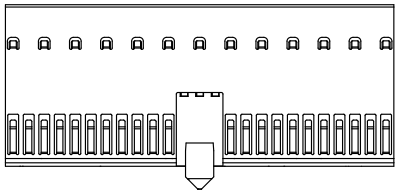
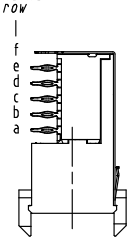
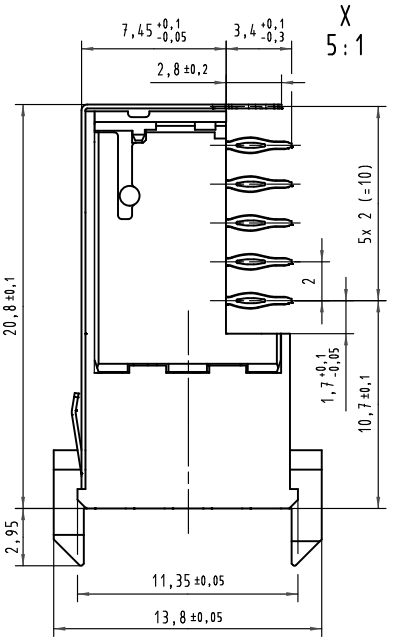
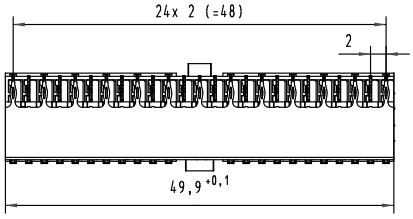




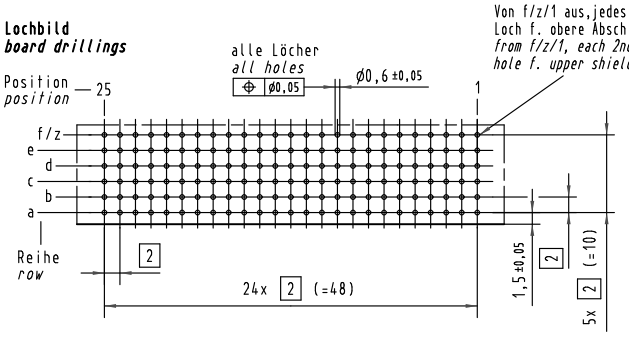








Lochbild
board drillings



Von f/z/1 aus, jedes 2. Loch f. obere Abschirmung
from f/z/1, each 2nd hole f. upper shielding

Bohrlochdurchmesser: Ø0,7 ±0,02 mm
Lochdurchmesser (mit Oberfläche): Ø0,6 ±0,05 mm
drill hole dia.: Ø0,7 ±0,02 mm
through hole dia. (after plating): Ø0,6 ±0,05 mm

Bestell-Nr. *part-no.*	Anforderungsstufe nach IEC *performance level acc. to IEC*	Kontaktoberfläche *contact plating*
17 35 125 4102	–	min.0,76µm (30µin) Au über/over min.1,27µm (50µin) Ni
17 35 125 2102	2	Au über/over Ni
17 35 125 1102	1	Au über/over Ni

Mod.	Dat.	Name
35456	01.12.08	TD
32387	19.11.04	Hl.
27619		

All Dimensions in mm
Original Size DIN A 3

Techn. Character.

	Dat.	Name
Detail.	01.06.01	Hm
Insp.	01.06.01	Ko
Stand.		

Maßstab/*Scale* 2:1 (5:1)

Nicht tolerierte Maße/*Free size tolerances* IEC 61076-4-101

har-bus HM Federleiste, Typ AB-25, 125 pol. mit Schirmblech Reihe-f
har-bus HM female connector, type AB-25, 125 pol. with shield row-f

HARTING Electronics GmbH & Co. KG
D-32339 ESPELKAMP

TB 17 35 125 x102

Blatt/*page*

Sub.

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